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SOP4, DC Input Photo Transistor Coupler

Description

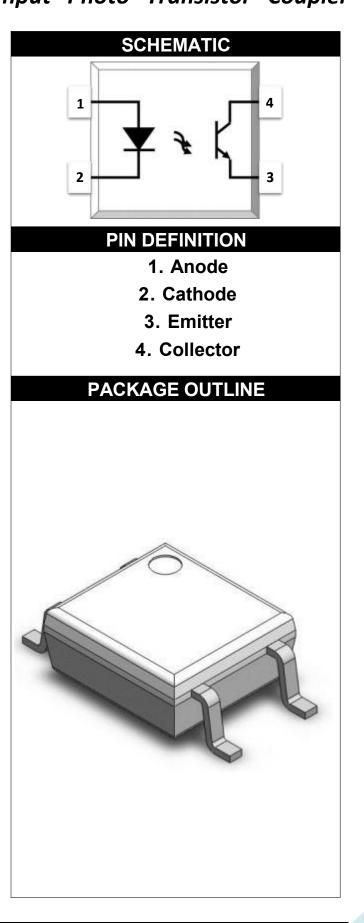
The TD351 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SOP4 package. With the robust coplanar double mold structure, TD351 series provide the most stable isolation feature.

Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment





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ABSOLUTE MA	XIMUM RAT	INGS					
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	lF	60	mĄ				
Peak Forward Current	I FP	1	A	1			
Reverse Voltage	VR	6	V				
Input Power Dissipation	Pı	100	m₩				
OU	TPUT						
Collector - Emitter Voltage	VCEO	350	V				
Emitter - Collector Voltage	VECO	7	V				
Collector Current	lc	50	mĄ				
Output Power Dissipation	Po	150	m₩				
COMMON							
Total Power Dissipation	Ptot	200	m₩				
Isolation Voltage	Viso	3750	Vrms	2			
Operating Temperature	Topr	-55~1 10	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R. H. = 40 $^{\sim}$ 60%



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ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAME	ETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	INPUT							
Forward V	/oltage	VF	-	1.24	1.4	V	IF=10mA	
Reverse C	Current	I _R	-	-	10	μĄ	VR=6V	
Input Capa	icitance	Cin	-	10	-	рF	V=0, f=1kHz	
				OUT	PUT			
Collector Dar	k Current	ICEO	-	-	100	nĄ	VCE=200V, IF=0	
Collector- I Breakdown		BVCEO	350	-	-	V	IC=0. 1mA, IF=0	
Emitter- Co Breakdown		BVECO	7	-	-	V	IE=0. 1mA, IF=0	
		TR	ANSFE	R CH	ARAC	TERIS	TICS	
Current Transfer Ratio	TD351	CTR	50	-	600	%	IF=5mA, VCE=5V	
Collector- I Saturation		V _{CE(sat)}	-	0.06	0.4	V	IF=20mA, IC=1mA	
Isolation Resistance		Riso	10^12	10^14		Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		Сю	-	0.4	1	PF	V=0, f=1MHz	
Response Time (Rise)		tr	-	3	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)		tf	-	4	18	μs	RL=100Ω	3
Cut-off Frequency		fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω ,-3dB	4

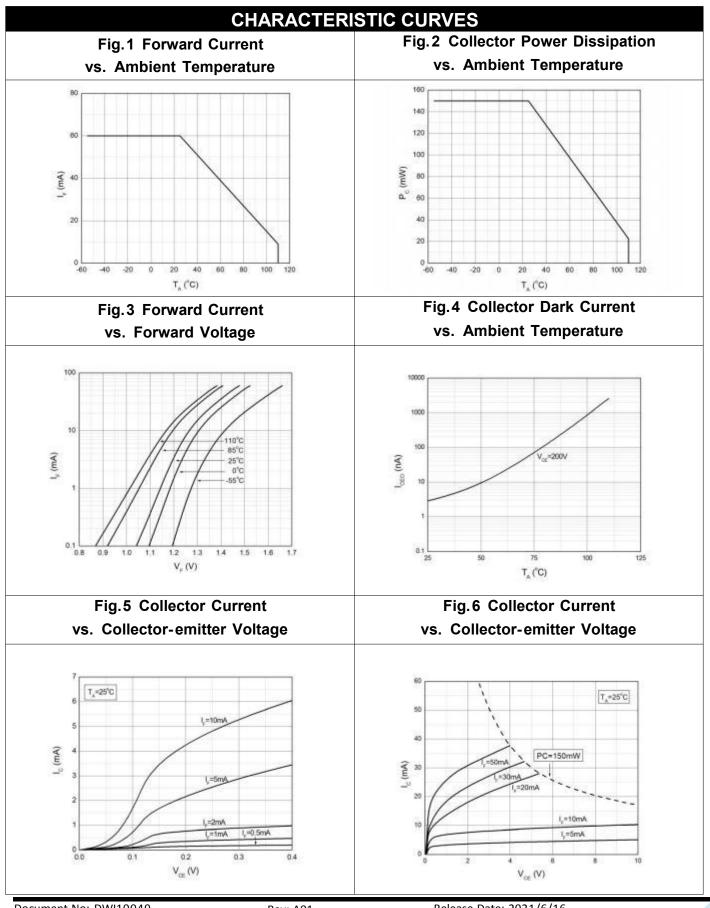
Note 3. Fig.12&13

Note 4. Fig.14



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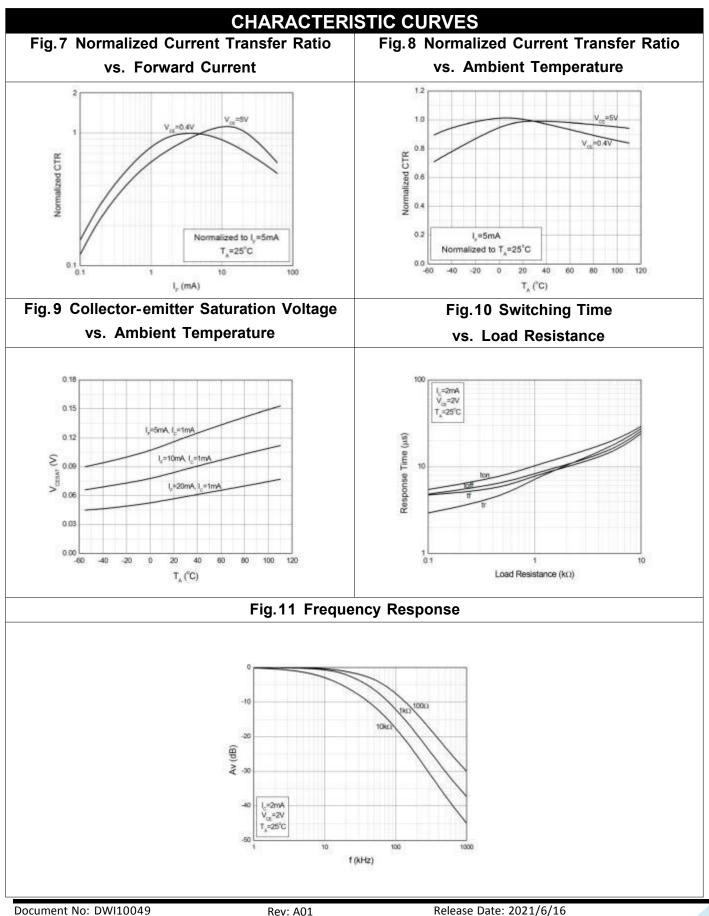
TD351 Series



LIGHTNING

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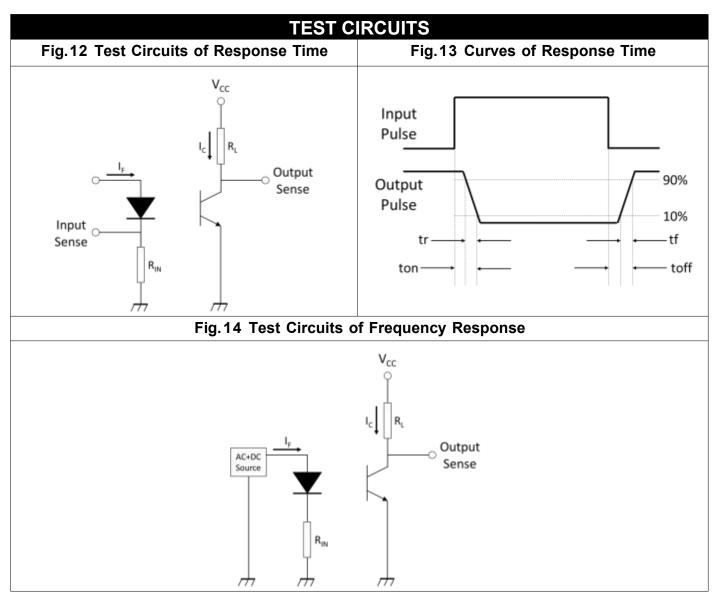


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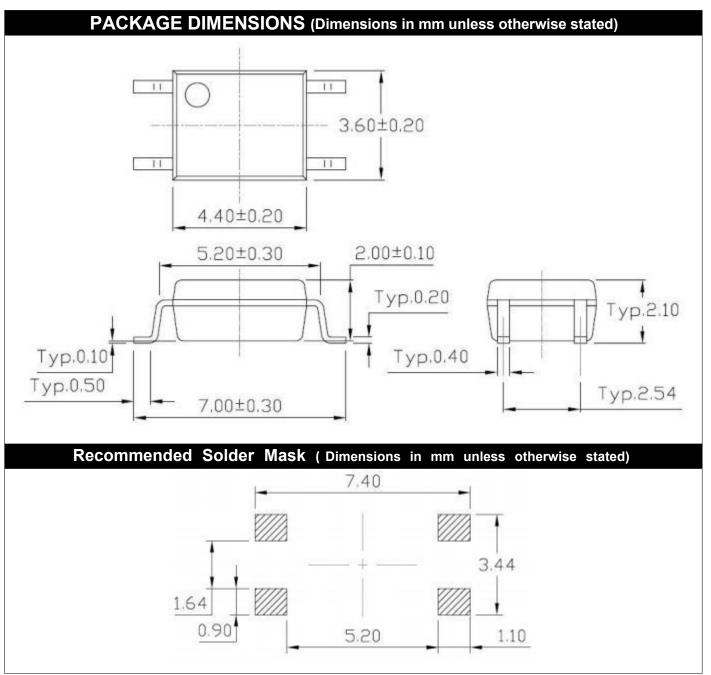
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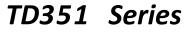
TD351 Series



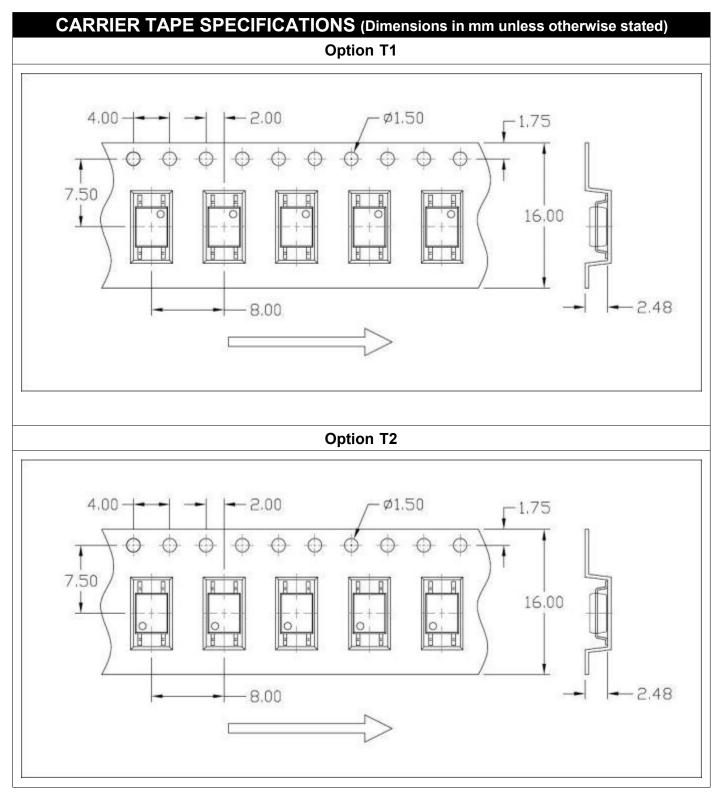








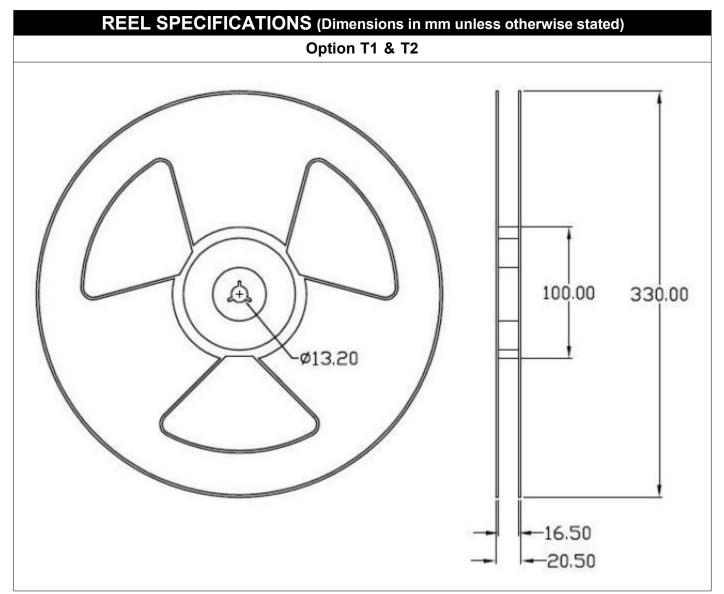






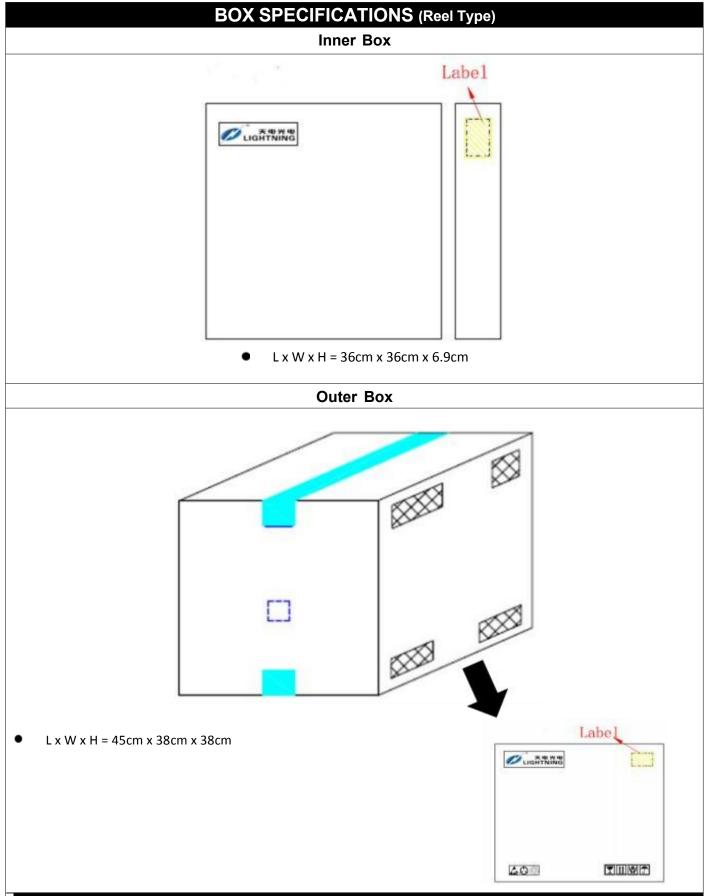


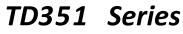
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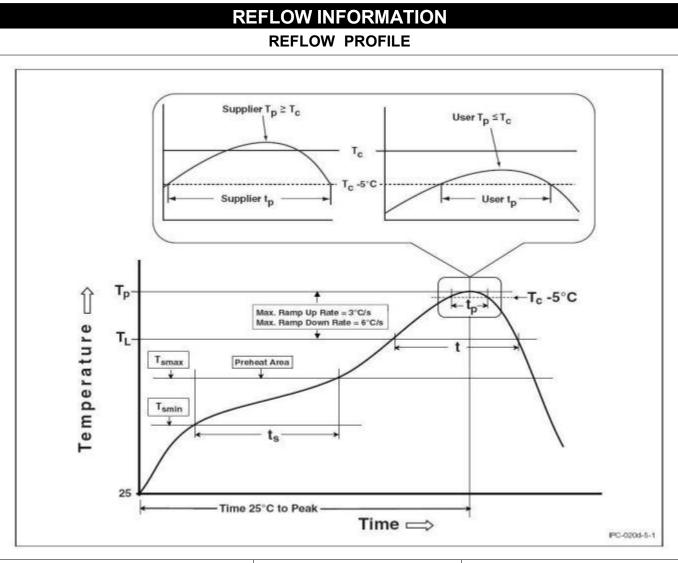


		GAND MARI MARKING INF		FORMATION ON		
	TD 351 VYAWW			: Company Abbr. : Part Number : VDE Option : Fiscal Year : Manufacturing Code : Work Week		
ORDERING INFORMATION			LABEL INFORMATION			
TD – Company Abbr. 351 – Part Number Z – Tape and Reel Option (T1/T2) G – Green V – VDE Option (V or None)			Alight Light Ligh			
			UANTITY	,		
Option	Quantity	Quantity – Inner box		Quantity – Outer box		
T1	3000 Units/Reel	3 Reels/Inner box		5 Inner box/Outer box = 45k Units		
T2	3000 Units/Reel 3 Reels/Inner			er box 5 Inner box/Outer box = 45k Units		





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Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	100	150°C		
Temperature Max. (Tsmax)	150	200°C		
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds		
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.		
Liquidous Temperature (TL)	183°C	217°C		
Time (tL) Maintained Above (TL)	60 - 150 seconds	60 – 150 seconds		
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C		
Time (tP) within 5°C of 260°C	20 seconds	30 seconds		
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max		
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.		

Document No: DWI10049



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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
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 customer application by the customer's technical experts. Product specifications do not expand or
 otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
 warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.